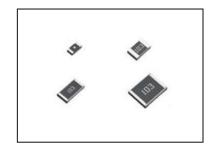
## High voltage resistance chip resistors KTR series

Datasheet

#### Features

- 1) Twice the rated voltage of conventional products.
- 2) Perfect for use in high voltage circuit. (Camera Flash circuit, etc)
- 3) ROHM resistors have obtained ISO9001 / IATF16949 certification.
- 4) Corresponds to AEC-Q200.



#### Products list

Part No.	Si	ze	Rated power (70°C)	power element Temperature Resistance Resistance range		Operating temperature range	Automotive Grade Available			
	(mm)	[inch]	(W)	(V)	(ppm/°C)	(%)	(Ω)	(°C)	(AEC-Q200)	
					±200	F ( ±1% )	1≦R≦10 (E24/96 series)			
KTR03	1608	0603	0.1	350	±100	F ( ±1% )	10≦R≦10M (E24/96 series)	-55 ∼ +155	Yes	
					±200	J ( ±5% )	1≦R≦10M (E24 series)			
KTR10	2012	0805	0.125	400	±100	F ( ±1% )	1≦R≦10M (E24/96 series)	-55 ∼ +155	Yes	
KIKIO	2012	0803	0.125	125 400	±200	J ( ±5% )	1≦R≦30M (E24 series)	-55 * 9 + 155		
KTR18	3216	1206	0.35	500	±100	F ( ±1% )	1≦R≦10M (E24/96 series)	-55 ∼ +155	Voo	
KIKIO	TR18 3216 1206 0.25		500	±200	J ( ±5% )	1≦R≦10M (E24 series)	-55 / 0 + 155	Yes		
KTR25	2005	2005 4040	005 4040	0.33	600	±100	F ( ±1% )	1≦R≦10M (E24/96 series)	-55 ∼ +155	Yes
KTK25	3225	1210 0.33		600	±200	J ( ±5% )	1≦R≦10M (E24 series)	-55 - 9 + 155	res	

Design and specifications are subject to change without notice. Carefully check the specification sheet supplied with the product before using or ordering it.

Rated voltage is determined from the following.

When rated voltage exceeds the limiting element voltage, the limiting element voltage shall be the rated voltage.

Rated voltage =  $\sqrt{\text{Rated power} \times \text{Resistance}}$ 

E24 : Standard products, E96 : Build to order

#### Part number description

**KTR** 10

Part No. KTR High voltage resistance chip resistors

Size	(mm)	[inch]
03	(1608)	[0603]
10	(2012)	[0805]
18	(3216)	[1206]
25	(3225)	[1210]

Part No.	Code Packaging specifications		Quantity / Reel (pcs)					
KTR03	F7P	Paper tape	5,000					
KIKUS	LZF	(4mm Pitch)	5,000					
KTR10	F7P	Paper tape	5,000					
KIKIU	LZF	(4mm Pitch)	5,000					
KTR18	F7D	Paper tape	5,000					

**EZP** 

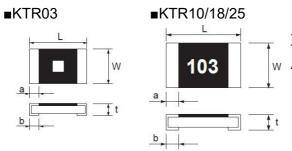
Type code						
Part No. Code		Packaging specifications	Quantity / Reel (pcs)			
KTR03	EZP	Paper tape	5,000			
111103	LZI	(4mm Pitch)	3,000			
KTR10	EZP	Paper tape	5,000			
KIKIU	LZP	(4mm Pitch)	5,000			
KTR18	EZP	Paper tape	5,000			
KIKIO	LZF	(4mm Pitch)	3,000			
KTR25	JZP	Embossed tape	4,000			
KIKZS	JZP	(4mm Pitch)	4,000			

tolerance F (±1%) J (±5%)

	Nominal resistance					
Re	esistar	nce	code,	3 or 4 digits.		
	Resis	star	nce	Resistance		
	tolera	anc	е	code		
		F	:	4 digits		
		J	:	3 digits		
E)	<b>×</b> )					
	1Ω	=	1R00	(±1%)		
			1R0	(±5%)		
	9.1Ω	=	9R10	(±1%)		
			9R1	(±5%)		
	10Ω	=	10R0	(±1%)		
			100	(±5%)		
	1ΜΩ	=	1004	(±1%)		
			105	(±5%)		

100

## •Chip resistor dimensions and markings



<Marking method>

There are three or four digits used for the calculation number.

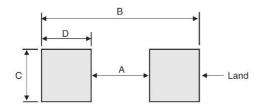
w And "R" is used for the decimal point.

(Unit: mm)

Part No.	(mm)	L	W	t	а	b	Marking existence
KTR03	1608	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20	*No
KTR10	2012	2.00±0.10	1.25±0.10	0.55±0.10	0.30±0.20	0.40±0.20	Yes
KTR18	3216	3.20±0.15	1.60±0.15	0.55±0.10	0.30±0.25	0.50±0.25	Yes
KTR25	3225	3.20±0.15	2.50±0.15	0.55±0.10	0.30±0.25	0.50±0.25	Yes

\*Only with square mark

### •Land pattern example



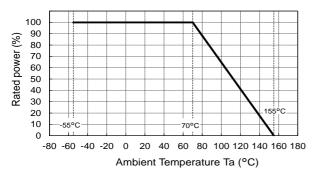
Dimensions Part No.	А	В	С	D
KTR03	1.0	2.0	0.8	0.5
KTR10	1.2	2.6	1.15	0.7
KTR18	2.2	4.0	1.5	0.9
KTR25	2.2	4.0	2.3	0.9

KTR series Datasheet

#### Derating curve

When the ambient temperature exceeds 70°C, power dissipation must be adjusted according to the derating curve below.

#### ■KTR03/10/18/25



#### Characteristics

Test items	Guaranteed Value	Test conditions
Resistance	See P.1	20°C
Variation of resistance	See P.1	Measurement: +25/-55, +25/+125°C
with temperature		
Overload	±(2.0%+0.1Ω)	Test voltage is the smaller one of ⊕ or ⊚
		①Rated voltage(current)×2.5
		②Maximum overload voltage *
		Test time : 2s
Solderability	A new uniform coating of minimum of 95% of the	Rosin-ethanol solution(25% mass)
	surface being immersed and no soldering damage.	Soldering condition: 245±5°C
		Duration of immersion: 2.0±0.5s
Resistance to	±(1.0%+0.05Ω)	Soldering condition: 260±5°C
soldering heat	No remarkable abnormality on the appearance.	Duration of immersion: 10±1s
Rapid change of	$\pm$ (1.0%+0.05Ω)	Test temp: -55°C~+125°C 5cycles
temperature		
Damp heat, steadystate	±(3.0%+0.1Ω)	40°C, 93%(Relative humidity)
		Test time: 1,000h
Endurance at 70°C	±(3.0%+0.1Ω)	Rated voltage(current),70°C
		1.5h:ON-0.5h:OFF
		Test time: 1,000h
Endurance	±(3.0%+0.1Ω)	155°C
		Test time: 1,000h
Resistance to solvent	$\pm$ (1.0% $\pm$ 0.05Ω)	23±5°C Immersion cleaning, 5±0.5min
		Solvent: 2-propanol
Bend strength of the	$\pm$ (1.0%+0.05Ω)	Endurance with 90mm width
end face plating	Without mechanical damage such as breaks.	Deflection: 3mm (KTR03/10/18)
		1mm (KTR25)

Compliance Standards : IEC 60115-1 / IEC 60115-8 JIS C 5201-1 / JIS C 5201-8

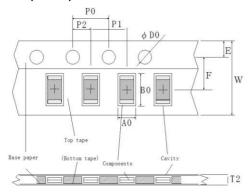
\*Maximum overload voltage (Test voltage)

KTR03	KTR10	KTR18	KTR25
500V	800V	1000V	1200V



KTR series Datasheet

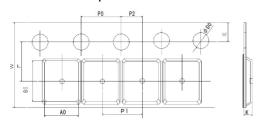
# •Tape dimensions ■Paper tape



Part No.	W	F	E	A0	В0
KTR03	8.0±0.3	3.5±0.05	1.75±0.1	1.1±0.1	1.9±0.1
KTR10	8.0±0.3	3.5±0.05	1.75±0.1	1.65+0.2 -0.1	2.4+0.2 -0.1
KTR18	8.0±0.3	3.5±0.05	1.75±0.1	1.95+0.1 -0.05	3.5+0.15 -0.05

Part No.	D0	P0	P1	P2	T2
KTR03	Ф1.5+0.1 0	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
KTR10	Ф1.5+0.1 0	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
KTR18	Ф1.5+0.1 0	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1

#### ■Embossed tape



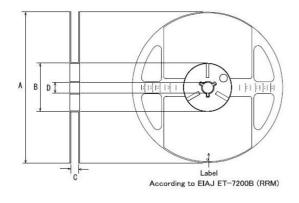
Unit:mm)

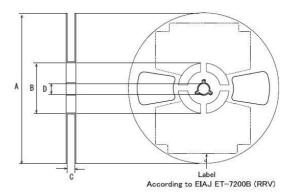
(Unit: mm)

Part No.	W	F	E	AO	В0
	8.0±0.3	3.5±0.05	1.75±0.1	3.0±0.1	3.5±0.1
KTR25	D0	P0	P1	P2	К
	Ф1.5 +0.1 0	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1

### •Reel dimensions

Using two kinds of reels for taping.





(Unit: mm)

Part No.	А	В	С	D
KTR03				
KTR10	Ф180 0	Ф60 +1.0	9 +1.0	Ф13±0.2
KTR18	-1.5	0	0	Ψ13±0.2
KTR25				

## **Notice**

#### **Precaution on using ROHM Products**

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN USA		EU	CHINA
CLASSIII	ОГУСОШ	CLASS II b	OL ACOM
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
  - [a] Installation of protection circuits or other protective devices to improve system safety
  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

#### **Precaution for Foreign Exchange and Foreign Trade act**

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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